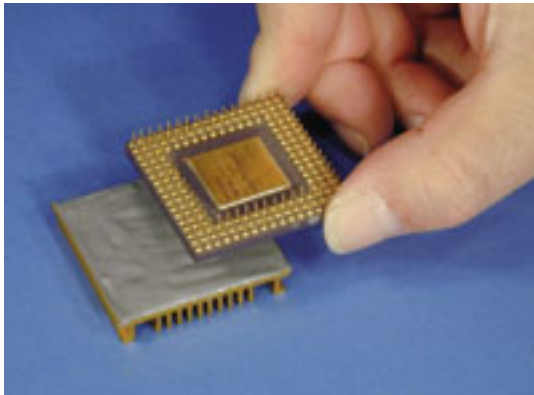


Thermally Conductive Adhesives Dissipate Heat



Duralco 132 thermally conductive adhesives from Cotronics Corporation combine high temperature resins with highly conductive fillers to form thermally conductive, adhesive bonds with continuous service up to 500°F. They are suitable for any industrial, electrical or electronic high-power applications, including bonding and assembling heating coils, cooling coils, heating elements, heat sinks, reaction vessels, semi-conductors, rectifiers, power supplies and replacement for soldering and welding. They provide optimal adhesion to metals, glass, ceramics and plastics, and offer resistance to chemicals solvents and moisture. The adhesives provide the heat dissipation required for high-temperature electronic and industrial applications. They are commonly used as a heat tracing adhesive that is used to bond heating or cooling tubing to equipment.

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